

BFG590; BFG590/X

NPN 5 GHz wideband transistors

Rev. 04 — 12 November 2007

Product data sheet

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NXP Semiconductors



BFG590; BFG590/X

FEATURES

- High power gain
- Low noise figure
- · High transition frequency
- Gold metallization ensures excellent reliability.

APPLICATIONS

- MATV/CATV amplifiers and RF communications subscriber equipment in the GHz range
- Ideally suitable for use in class-A, (A)B and C amplifiers with either pulsed or continuous drive.

DESCRIPTION

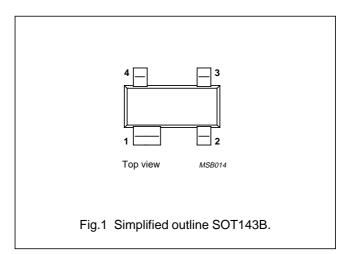
NPN silicon planar epitaxial transistor in a 4-pin dual-emitter SOT143B plastic package.

MARKING

TYPE NUMBER	CODE
BFG590	%МН
BFG590/X	%MN

PINNING

PIN	DESCRIPTION					
PIN	BFG590	BFG590/X				
1	collector	collector				
2	base	emitter				
3	emitter	base				
4	emitter	emitter				



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	_	20	V
V _{CEO}	collector-emitter voltage	open base	_	_	15	V
I _C	collector current (DC)		_	_	200	mA
P _{tot}	total power dissipation	T _s ≤ 60 °C	_	_	400	mW
h _{FE}	DC current gain	I _C = 35 mA; V _{CE} = 8 V	50	90	280	
C _{re}	feedback capacitance	I _C = 0; V _{CE} = 8 V; f = 1 MHz	_	0.7	_	pF
f _T	transition frequency	$I_C = 80 \text{ mA}; V_{CE} = 4 \text{ V}; f = 1 \text{ GHz}$	_	5	_	GHz
G _{UM}	maximum unilateral power gain	I_C = 80 mA; V_{CE} = 4 V; f = 900 MHz; T_{amb} = 25 °C	_	13	_	dB
$ S_{21} ^2$	insertion power gain	$I_C = 80 \text{ mA}; V_{CE} = 4 \text{ V};$ f = 900 MHz; $T_{amb} = 25 \text{ °C}$	_	11	_	dB

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V_{CEO}	collector-emitter voltage	open base	_	15	V
V _{EBO}	emitter-base voltage	open collector	_	3	V
I _C	collector current (DC)		_	200	mA
P _{tot}	total power dissipation	T _s ≤ 60 °C; see Fig.2; note 1	_	400	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	175	°C

Note

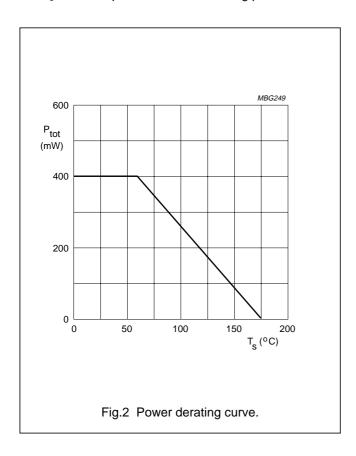
1. T_{S} is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	T _s ≤ 60 °C; note 1	290	K/W

Note

1. T_{S} is the temperature at the soldering point of the collector pin.



NXP Semiconductors Product specification

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CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)CBO}	collector-base breakdown voltage	$I_C = 0.1 \text{ mA}; I_E = 0$	20	_	_	V
V _{(BR)CEO}	collector-emitter breakdown voltage	$I_C = 10 \text{ mA}; I_B = 0$	15	_	_	V
V _{(BR)EBO}	emitter-base breakdown voltage	$I_E = 0.1 \text{ mA}; I_C = 0$	3	_	_	V
I _{CBO}	collector-base leakage current	V _{CB} = 10 V; I _E = 0	_	_	100	nA
h _{FE}	DC current gain	I _C = 70 mA; V _{CE} = 8 V; see Fig.3	60	120	250	
f _T	transition frequency	I _C = 80 mA; V _{CE} = 4 V; f = 1 GHz; see Fig.5	_	5	_	GHz
C _{re}	feedback capacitance	$I_C = 0$; $V_{CB} = 8 \text{ V}$; $f = 1 \text{ MHz}$; see Fig.4	_	0.7	_	pF
G _{UM}	maximum unilateral power gain; note 1	I _C = 80 mA; V _{CE} = 4 V; f = 900 MHz; T _{amb} = 25 °C	_	13	_	dB
		$I_C = 80 \text{ mA}; V_{CE} = 4 \text{ V}; f = 2 \text{ GHz}; $ $T_{amb} = 25 \text{ °C}$	_	7.5	_	dB
S ₂₁ ²	insertion power gain	I _C = 80 mA; V _{CE} = 4 V; f = 900 MHz; T _{amb} = 25 °C	_	11	_	dB

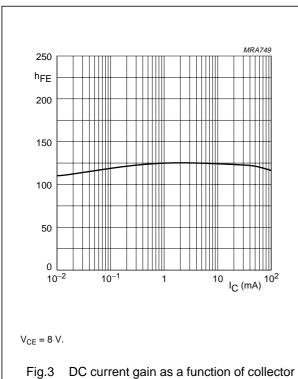
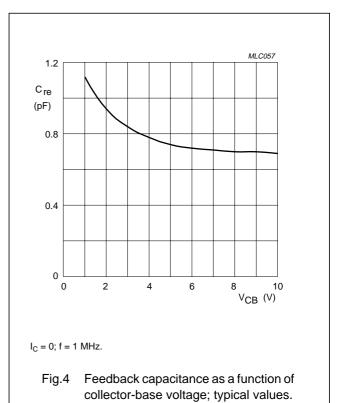
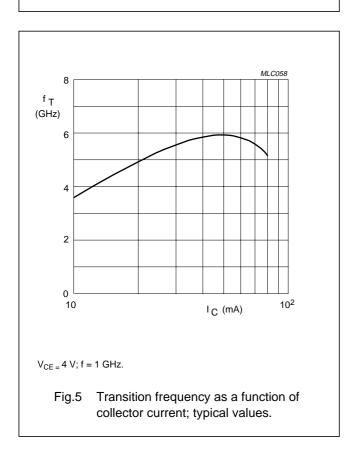
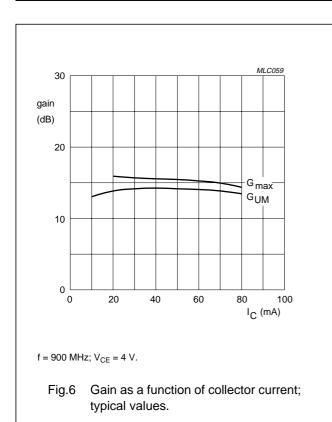
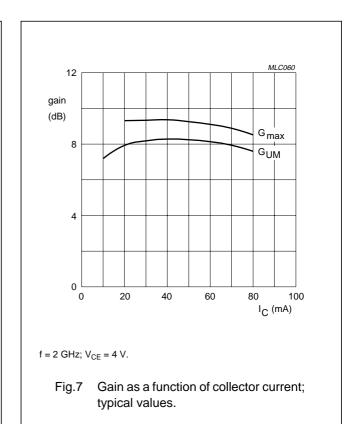


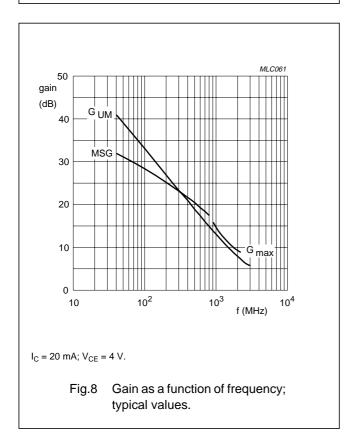
Fig.3 DC current gain as a function of collector current; typical values.

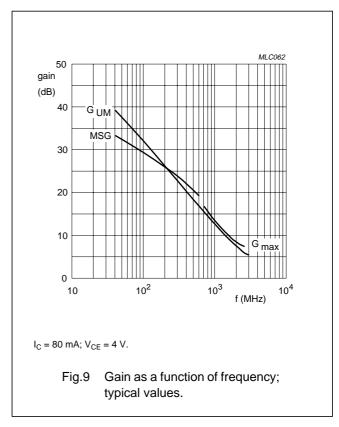


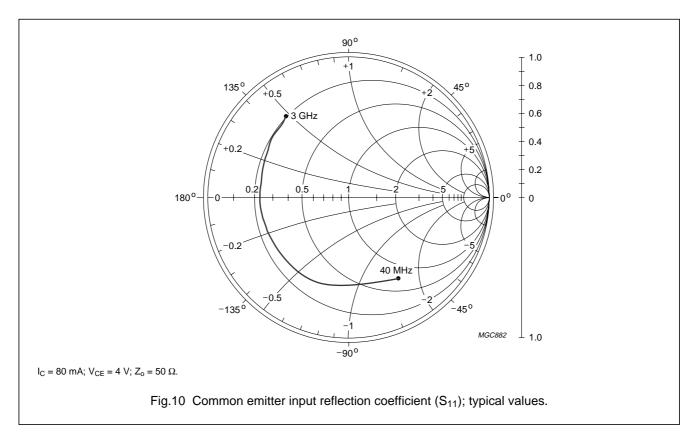


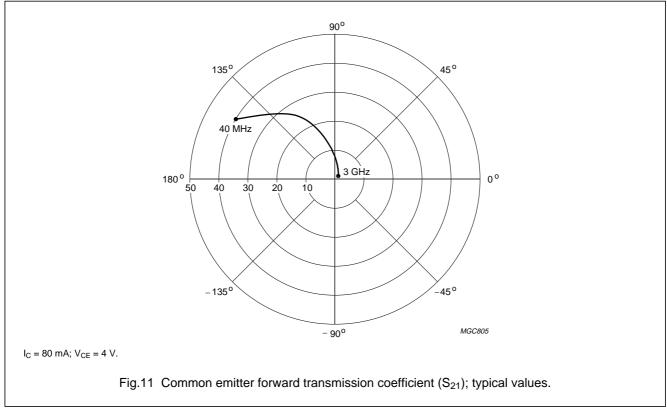


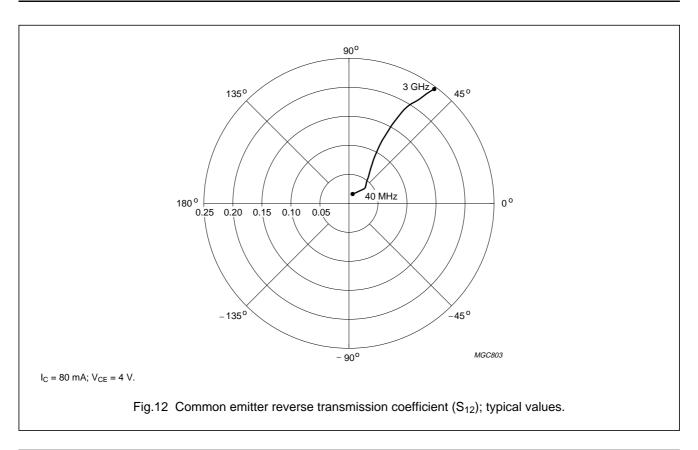


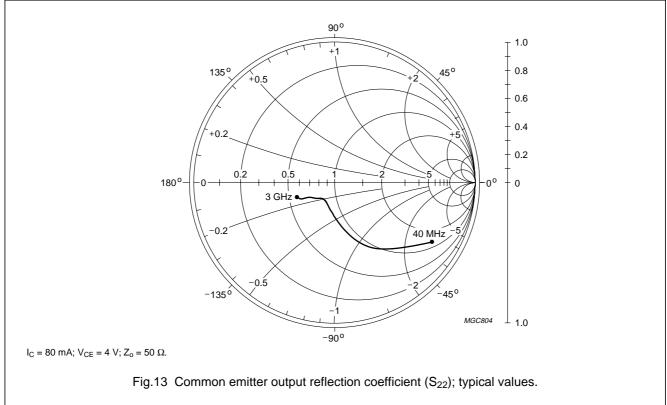










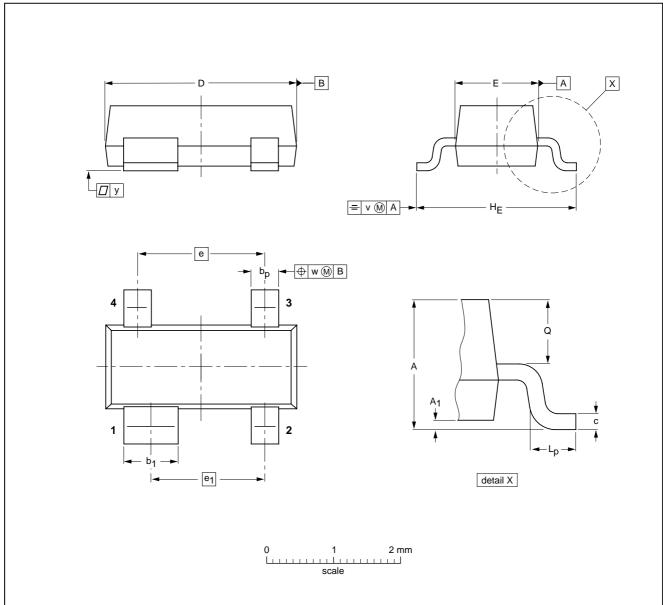


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PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

SOT143B



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	bp	b ₁	С	D	E	е	e ₁	HE	L _p	Q	v	w	у
mm	1.1 0.9	0.1	0.48 0.38	0.88 0.78	0.15 0.09	3.0 2.8	1.4 1.2	1.9	1.7	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1	0.1

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION 155	155UE DATE
SOT143B						97-02-28

Legal information

Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFG590_X_N_4	20071112	Product data sheet	-	BFG590_X_3
Modifications:	 Fig. 1 and 2 	2 on page 2; Figure note chan	ged	
BFG590_X_3 (9397 750 04346)	19981002	Product specification	-	BFG590XR_2
BFG590XR_2	19950919	Product specification	-	BFG590XR_1
BFG590XR_1	19921101	Preliminary specification	-	-

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